

Bill of Materials

Bill of Materials For PCB Document [Backplane_Tight.PcbDoc]

Source Data From: Backplane_Tight.PcbDoc
 Project: Backplane.PrjPcb
 Variant: None

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Footprint	Comment	LibRef	Designator	Description	Quantity
CAPC4532M	Bourns MF-MSMF014-2	Fuse Thermal	F1, F5, F9	Thermal Fuse	3
RAD-0.2	Tyco RUSBF120	Fuse Thermal	F2, F4, F6, F8, F10, F12	Thermal Fuse	6
RAD-0.2	Bourns CMF-RL35-0	Fuse Thermal	F3, F7, F11	Thermal Fuse	3
LEMO EPA.00	LEMO EPA.00	LEMO EPA.00	IND11, IND12, IND13, IND14, IND15,		11
EURO2.54-2V64A	Hirose PCN10-64S-2.54DSA(72)	DIN41612 48 pin	P1, P2, P3, P4, P5, P6	Header, 5-Pin, Dual row, Header, 6-Pin	6
EURO2.54-2V48	Hirose PCN10-48S-2.54DSA(72)	DIN41612 48 pin	P7, P9, P11		3
HDR2X8	Molex 10-89-7162	Header 8X2	P8, P10, P12	Header, 8-Pin, Dual row	3
10-84-4120	Molex 10-84-4120	10-84-4120	P13		1
HDR1X2	Molex 22-03-2021	Jumper	W1	Jumper Wire	1
					37

Approved	Notes